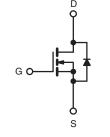
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.125				
Q _g max. (nC)	130				
Q _{gs} (nC)	15				
Q _{gd} (nC)	39				
Configuration	Single				





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
 - LED lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers
- Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION					
Package	TO-220AB				
Lead (Pb)-free	SiHP30N60E-E3				
Lead (Pb)-free and Halogen-free	SiHP30N60E-GE3				

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	600	V	
Gate-Source Voltage			V _{GS}	± 30	V	
Continuous Drain Current (T _J = 150 °C)	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	I _D	29		
	V _{GS} at 10 V	T _C = 100 °C		18	А	
Pulsed Drain Current ^a			I _{DM}	65		
Linear Derating Factor				2	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	690	mJ	
Maximum Power Dissipation			PD	250	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	$V_{DS} = 0 V \text{ to } 80 \% V_{DS}$			70		
Reverse Diode dV/dt ^d			dV/dt	18	V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s				300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_a = 25 \Omega$, $I_{AS} = 7$ A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

S15-0277- Rev. G, 23-Feb-15

1 For technical questions, contact: hvm@vishay.com



COMPLIANT

HALOGEN FREE



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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	- 62			°C 111			
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.5					°C/W	
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	nless otherwi	se noted)			T	1		
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D =	250 µA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C,	I _D = 250 μA	-	0.64	-	V/°0
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2.0	2.8	4.0	V
Cata Sauraa Laakaga	I		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zara Cata Valtaga Drain Current		V _{DS} =	= 600 V, V ₀	_{as} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 600 V	/, V _{GS} = 0	V, T _J = 150 °C	-	-	100	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	l	_D = 15 A	-	0.104	0.125	Ω
Forward Transconductance ^a	9 _{fs}	V _D	_S = 8 V, I _D	= 3 A	-	5.4	-	S
Dynamic								
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1.0 MHz		-	2600	-	-	
Output Capacitance	C _{oss}			-	138	-		
Reverse Transfer Capacitance	C _{rss}			-	3	-		
Effective Output Capacitance, Energy Related ^b	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	98	-	pF	
Effective Output Capacitance, Time Related ^c	C _{o(tr)}			-	346	-	1	
Total Gate Charge	Qg				-	85	130	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 15 A, V _{DS} = 480 V		-	15	-	nC
Gate-Drain Charge	Q _{gd}				-	39	-	
Turn-On Delay Time	t _{d(on)}				-	19	40	
Rise Time	t _r	V _{PP} -	= 380 V, I _D	– 15 A	-	32	65	- ns
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	= 10 V, R _g	$= 4.7 \Omega$	-	63	95	
Fall Time	t _f	9		-	36	75	1	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.63	-	Ω	
Drain-Source Body Diode Characteristic								
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	29		
Pulsed Diode Forward Current	I _{SM}			-	-	65	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 15 A, V _{GS} = 0 V		-	-	1.3	V	
Body Diode Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 15 \text{ A},$ dl/dt = 100 A/µs, V _R = 20 V		-	402	605	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	7	15	μΟ	
Reverse Recovery Current	I _{RRM}			_	32	65	A	
Hereice Hoodvery Guitein	'KKIVI				02	00	7	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

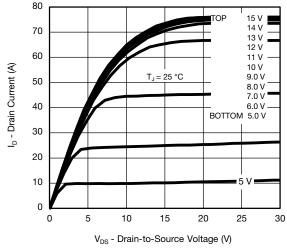
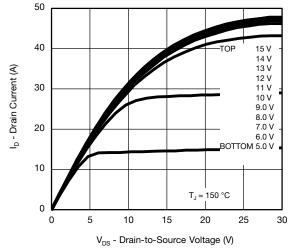
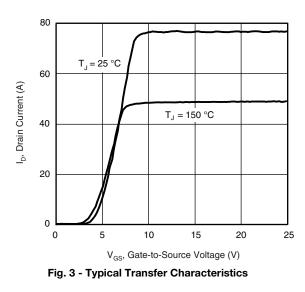


Fig. 1 - Typical Output Characteristics, T_C = 25 °C







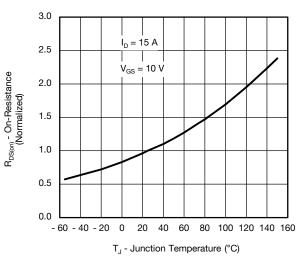


Fig. 4 - Normalized On-Resistance vs. Temperature

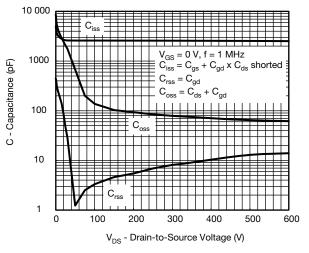
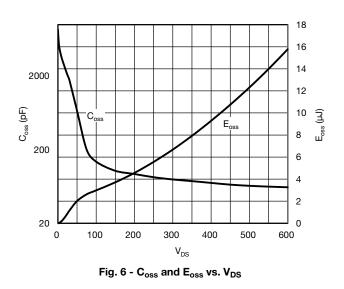


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91456

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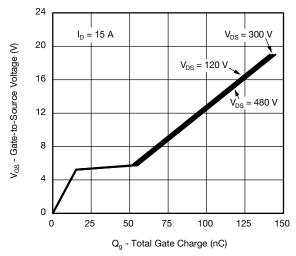


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

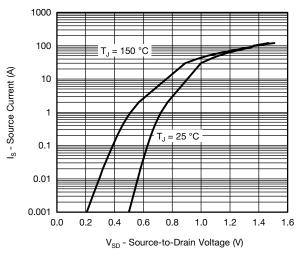


Fig. 8 - Typical Source-Drain Diode Forward Voltage

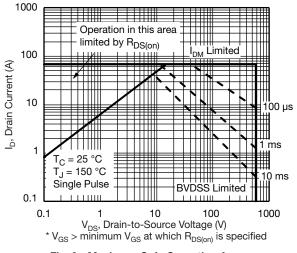


Fig. 9 - Maximum Safe Operating Area

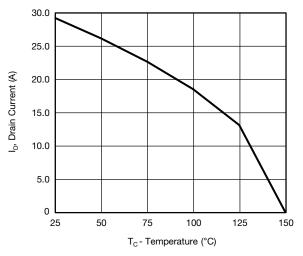


Fig. 10 - Maximum Drain Current vs. Case Temperature

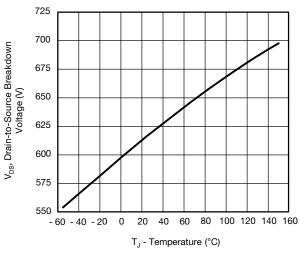
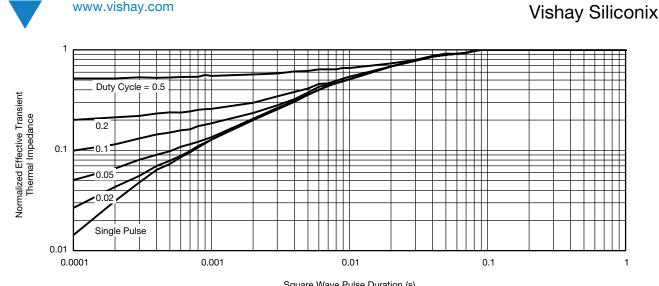


Fig. 11 - Temperature vs. Drain-to-Source Voltage

4



Square Wave Pulse Duration (s) Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

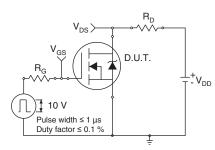


Fig. 13 - Switching Time Test Circuit

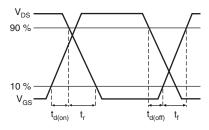


Fig. 14 - Switching Time Waveforms

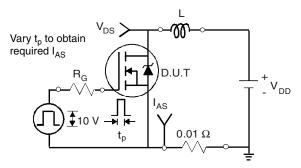


Fig. 15 - Unclamped Inductive Test Circuit

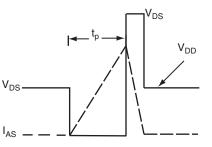


Fig. 16 - Unclamped Inductive Waveforms

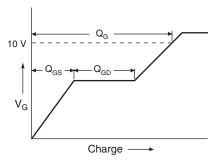


Fig. 17 - Basic Gate Charge Waveform

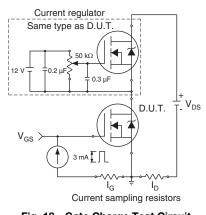


Fig. 18 - Gate Charge Test Circuit

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5



SHAY

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Peak Diode Recovery dV/dt Test Circuit

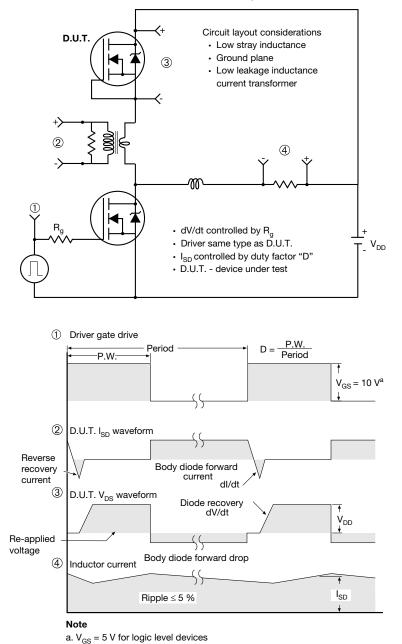
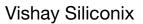


Fig. 19 - For N-Channel

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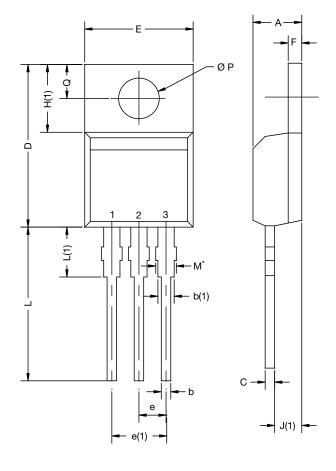
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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIIVI.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

Document Number: 66542

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